OT 1 0 2002 W

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Confirmation No. 3064

Hiroaki INOUE et al.

Docket No. 2001\_1094A

Serial No. 09/890,455

Group Art Unit 2812

Filed March 12, 2002

Examiner L. Gurley

ELECTROLESS PLATING LIQUID AND METHOD OF FORMING INTERCONNECTION USING SUCH AN ELECTROLESS PLATING LIQUID

THE COMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE FEES FOR THIS PAPER TO DEPOSIT ACCOUNT NO. 23-0975

## **AMENDMENT**

Assistant Commissioner for Patents, Washington, D.C.

Sir:

Responsive to the Official Action dated September 18, 2002 please amend the above-identified application as follows:

## **IN THE CLAIMS:**

Cancel without prejudice claims 1-4.

1. manuflan PCC/No. 207 10/1402

## **REMARKS:**

The Official Action constitutes a requirement for restriction.

Applicants select to prosecute the invention of Group I, claims 5-17, without traverse.

The non-elected claims have been cancelled without prejudice to the filing of a divisional application thereto.

Favorable action on the merits is solicited.

Respectfully submitted,

Hiroaki INOUE et al.

Bv

Warren M. Cheek, Jr

Registration No. 33,367

Attorney for Applicants

WMC/abm Washington, D.C. 20006-1021 Telephone (202) 721-8200 Facsimile (202) 721-8250 October 10, 2002